PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SOO-TAE LEE	04/11/2014
TAE-SUNG PYO	04/11/2014
SU-KYU LEE	04/11/2014

RECEIVING PARTY DATA

Name:	PANASIA CO., LTD	
Street Address:	1559-3, SONGJUNG-DONG	
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City:	BUSAN	
State/Country:	KOREA, REPUBLIC OF	
Postal Code:	464-050	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14351612

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	15813.27
NAME OF SUBMITTER:	DANA L. TANGREN
SIGNATURE:	/dana I. tangern/
DATE SIGNED:	04/14/2014
	This document serves as an Oath/Declaration (37 CFR 1.63).

Total Attachments: 3

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PATENT REEL: 032682 FRAME: 0583

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> PATENT REEL: 032682 FRAME: 0584

UNITED STATES PATENT

Form Foreign

COMBINED DECLARATION and ASSIGNMENT

(Utility, Design, National Stage of PCT)

TITLE OF INVENTION: CANDLE-TYPE FILTERING DEVICE FOR PREVENTING BACK PRESSURE

As a below named inventor, I hereby declare that:

SPECIFICATION IDENTIFICATION

This declaration and assignment is directed to:

		$(complete (a), (b), or (c))^3$
(a)		The attached application (United States Application No,
		filed on);
(b)		Previously filed United States Application No.
		filed on; or
(c)	[X]	PCT International Application No. PCT/KR2011/007822, filed on October 20,
		2011 (nationalized as United States Application No.
		14/351,612 , filed on April 14, 2014).

I hereby authorize the patent attorneys and/or patent agents of Workman Nydegger to insert the above Application No(s), and filing date(s) when known.

DECLARATION AND ACKNOWLEDGEMENT

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the above-identified application.

I hereby state that I have reviewed and understand the contents of the above-identified application, including the claim(s).

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I acknowledge the duty to disclose all information which is material to patentability as defined in 37 C.F.R. § 1.56, including for continuation-in-part applications, material information which became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. § 1001 by fine or imprisonment of not more than five (5) years, or both.

ASSIGNMENT⁴

The Assignee, PANASIA CO., LTD., having a principal place of business at 1559-3, Songjungdong, Gangseo-gu, Busan, Republic of Korea 464-050, desires to secure the entire right, title and interest in the above-identified application.

In consideration of One Dollar (\$1,00) and other good and valuable consideration paid to me by the Assignee, the receipt and sufficiency of which is hereby acknowledged, I HEREBY ASSIGN TO THE ASSIGNEE:

The entire right, title and interest in the above-identified application and in all divisions, continuations and continuations-in-part of said application and in all patents issuing thereon in the United States and in all reissues or extensions of patents granted thereon.

The right to claim priority to or the benefit of any prior related United States or foreign patent applications including under all applicable treaties and conventions.

I hereby authorize and request the United States Commissioner of Patents and Trademarks, to issue any and all patents on said application to the Assignee as the owner of the entire interest, for the sole use and behoof of the said Assignee, its successors, assigns and legal representatives.

I hereby agree, without further consideration, to sign all lawful papers and to perform all other lawful acts which the Assignee may request me to make this Assignment fully effective, including, by way of example but not of limitation, the following:

Prompt execution of all original, divisional, continuation, continuation-in-part, substitute, reissue, and other United States applications and all lawful documents requested by the Assignee to further the prosecution of any of such patent applications.

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With regard to the above-identified application and applications claiming priority thereto, cooperate to the best of my ability in: (1) proceedings relating to nullification, reissue, extension, post grant, inter parties, derivation, supplemental examination, and infringement; (2) execution of all lawful documents; and (3) the production of evidence.

This assignment and agreement shall be binding upon my heirs and legal representatives.

SIGNATURE(S)5

NOTE: Carefully indicate the family (or lust) name, as it should appear on the filing receipt and all other documents.

Ful	name of	sole or	first	inventor
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Soo-Tae	Lee		
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RECORDED: 04/14/2014